SP	F	CI	FI	CA	TI	<b>(</b> )	N	15
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CUSTOMER . CIT008

SAMPLE CODE . SE128128WRF-005-HQ

MASS PRODUCTION CODE . PE128128WRF-005-HQ

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 009

DRAWING NO. (Ver.) . LMD-PE128128WRF-005-HQ\_002

PACKAGING NO. (Ver.) . JPKG- PE128128WRF-005-HQ\_003

# **Customer Approved**

Date:

POWERTIP 2013.02.06 JS RD APPROVED

Approved	Checked	Designer
閆偉	劉進	譚超敏

- Preliminary specification for design input
- Specification for sample approval

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# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
02/22/2008	01	001	New drawing	-	Timter
03/27/2008	01	002	Modify pin Assignment	P.15	Timter
05/07/2008	01	003	Modify DC Electrical Characteristics  Modify Optical Characteristics  Modify Backlight Characteristics	P.5 P.6 P.11	Timter
08/13/2009	01	004	First Sample	-	Timter
10/05/2009	01	005	Modify 1.3 Absolute Maximum Ratings Modify 1.5 Optical Characteristics Modify 1.6 Backlight Characteristics Modify 2.4 Reference Power supply circuit Modify Packing Specification	P.4 P.6 P.11 P.17 Appendix	Timter
10/18/2010	01	006	Modify 1.1 Features (ROHS Web)  Modify 1.6 Backlight Characteristics (Maximum Ratings, IF)	P.4 P.11	Timter
09/13/2011	01	007	Modify Packing Specification	Appendix	Lori
09/28/2011	01	008	Update The Full Novatek Ordering Code	P.3 P.4 Appendix	Lori
01/31/2013	01	009	Change BIAS from 1/9 to 1/8  Modify Dc Electrical characteristics  Modify Optical Characteristics	P.4 P.5 P.6	譚超敏
	X				
		X			

Total: 27



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Appendix: 1. LCM Drawing

2. Packing Specification

Note: For detailed information please refer to IC data sheet: NOVATEK—NT7508H-D01/3E



### 1. SPECIFICATIONS

### 1.1 Features

Item	Standard Value
Display Type	128 * 128 Dots
LCD Type	FSTN, Positive, Transflective
Driver Condition	LCD Module: 1/128 Duty, 1/8 Bias,
Viewing Direction	6 O'clock
Backlight	LED
Weight	65 g
Interface	Parallel
Other (controller / driver IC)	NOVATEK – NT7508H-D01/3E
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit			
Outline Dimension	75.0 (W) * 85.0(L) * 6.0 (H)	mm			
Viewing Area	69.0 (W) * 69.0 (L)	mm			
Active Area	63.345 (W) * 63.345 (L)	mm			
Dot Size	0.48 (W) * 0.48 (H)	mm			
Dot Pitch	0.495 (W) * 0.495 (H)	mm			

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

		•			
Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	$V_{DD}$	_	-0.3	4.0	V
LCD Driver Supply Voltage	$V_{LCD}$	_	-0.3	15.0	V
Input Voltage	V <sub>IN</sub>	_	-0.3	V <sub>dd</sub> +0.3	V
Operating Temperature	T <sub>OP</sub>	_	-20	70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T <sub>ST</sub>	_	-30	80	$^{\circ}\!\mathbb{C}$

Note: Temperature coefficient : -0,05%/°C and firmware code must use" 0xF1, 0x01".



## 1.4 DC Electrical Characteristics

Module

 $V_{DD}$  = 3.0 $\pm$ 0.3V,  $V_{SS}$  = 0V, Ta = 25 $^{\circ}$ C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	$V_{DD}$	_	2.7	3.0	3.3	V
Input High Voltage	V <sub>IH</sub>	_	0.8VDD	_	VDD	V
Input Low Voltage	V <sub>IL</sub>	_	VSS		0.2VDD	٧
Output High Voltage	V <sub>OH</sub>	IOH = -0.5mA	0.8VDD	-	VDD	V
Output Low Voltage	V <sub>OL</sub>	IOL = -0.5mA	VSS	_	0.2VDD	V
0 1 0 1		VDD=3.0 V ; VOP=13.8 V Pattern= Full Display	_	1	_	•
Supply Current	I <sub>DD</sub>	VDD=3.0 V ; VOP=13.8 V Pattern= ABB menu*1	+	1.5	2	mA
	V <sub>OP</sub>	<b>-20</b> °C	13.8	14.0	14.2	
LCM Driver Voltage	V OP	25℃	13.6	13.8	14.0	V
	*2	70℃	13.2	13.4	13.6	

NOTE: \*1 The Maximum current display.

\*2 The  $V_{\text{OP}}$  test point is V0-VSS.





## 1.5 Optical Characteristics

LCD Panel : Duty=1/128  $\cdot$  Bias=1/8  $\cdot$  V<sub>OP</sub>=13.8V  $\cdot$  Ta =25 $^{\circ}$ C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
		Tr(60°C)		_	65	_^		
	Rise	Tr(25°ℂ)		_	142	213		
Response Time		Tr(-10°€)		_	970		ms	Note 2
Troopened Time		Tf(60°C)		_	150	_		11010 2
	Fall	Tf(25°ℂ)	C <u>&gt;</u> 2.0,	_	422	633		<b>&gt;</b>
		Tf(-10°C)	Ø = 270 °		3620	-		
	Тор	⊖Y+		_	45			
Viewing angle	Bottom	⊖ <b>Y</b> -		_	45	_	Deg.	Note 1
range	Left	⊖ <b>X</b> -		_	45	-	Deg.	Note i
	Right	⊖ <b>X</b> +			45			
Contrast Ra (With BL)		CR	$\theta = 0^{\circ},$ $\emptyset = 270^{\circ}$	4	6		_	Note 3
Average Bright (With BL) *		IV	IF=2 x 30	40	(55)		cd/m <sup>2</sup>	_
CIE Color Coordinate (With BL) *2		X	mA	0.28	0.33	0.38		
		Y		0.30	0.35	0.40	_	_
Uniformity '	<b>'</b> 1	∆B	_	70	_	_	%	_

#### Note:

\*1 : △B=B(min) / B(max) \* 100%

\*2 : Measurement Condition for Optical Characteristics:

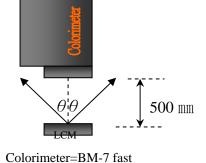
a : Environment: 25°℃±5°℃ / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance:  $500 \pm 50$  mm  $\rightarrow$  ( $\theta = 0^{\circ}$ )

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%

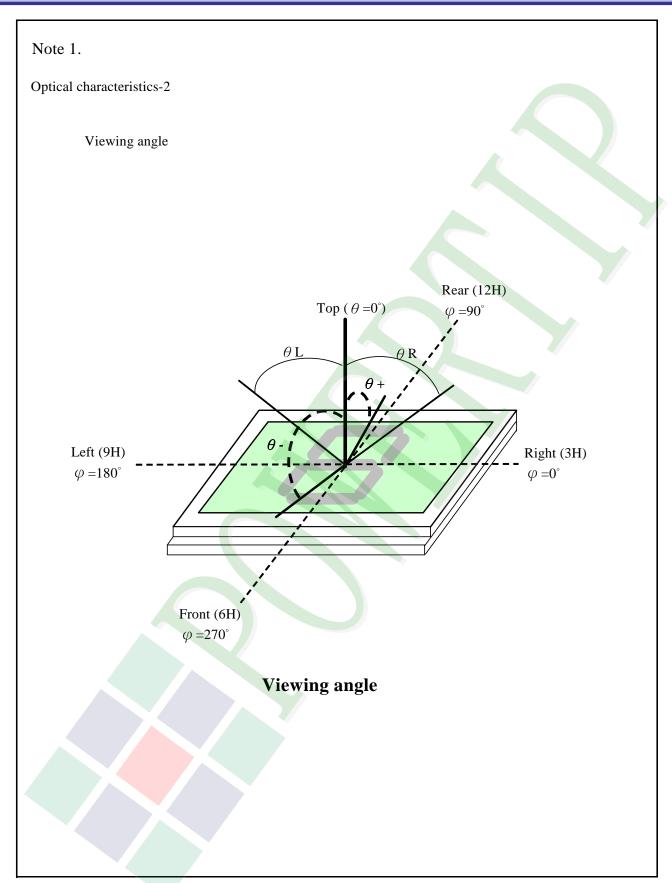




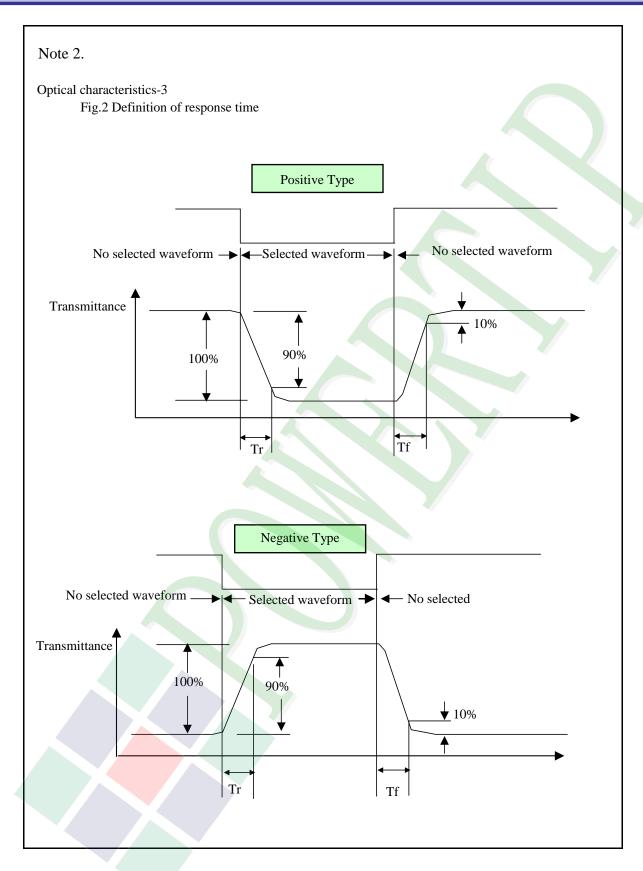
SPEC Edi.009

PE128128WRF-005-HQ Page6 SAMPLE Ver.01











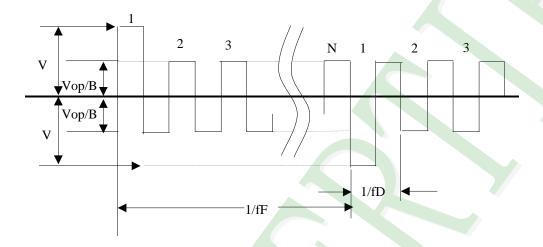
#### Electrical characteristics-2

**※**2 Drive waveform

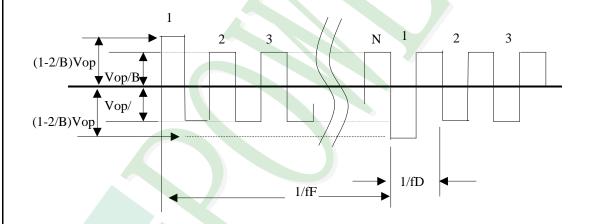
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

#### (1) Selected waveform



#### (2) Non- Selected wave form

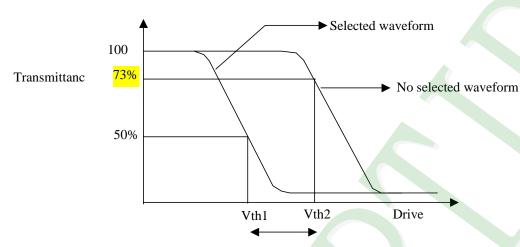


#### Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period



Note 3.: Definition of Vth



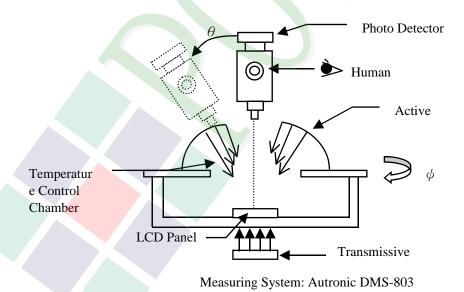
Active voltage range

	Vth1	Vth2
View direction	10°	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

#### **※**1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





## 1.6 Backlight Characteristics

LCD Module with LED Backlight

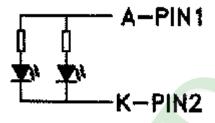
Maximum Ratings

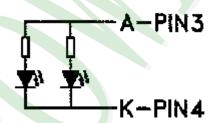
Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃	_	2 x 40	mA
Reverse Voltage	VR	Ta =25°ℂ	- 🔨	5	V
Power Dissipation	PD	Ta =25°℃		2 x 105	mW

**Electrical / Optical Characteristics** 

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=2 x 30 mA	3.1	3.3	3.5	V
CIE Color Coordinate	Х	IF=2 x 30 mA	0.27	0.30	0.33	
(Without LCD)	Υ	1F-2 X 30 IIIA	0.28	0.31	0.34	_
Color			White			

Internal Circuit Diagram:







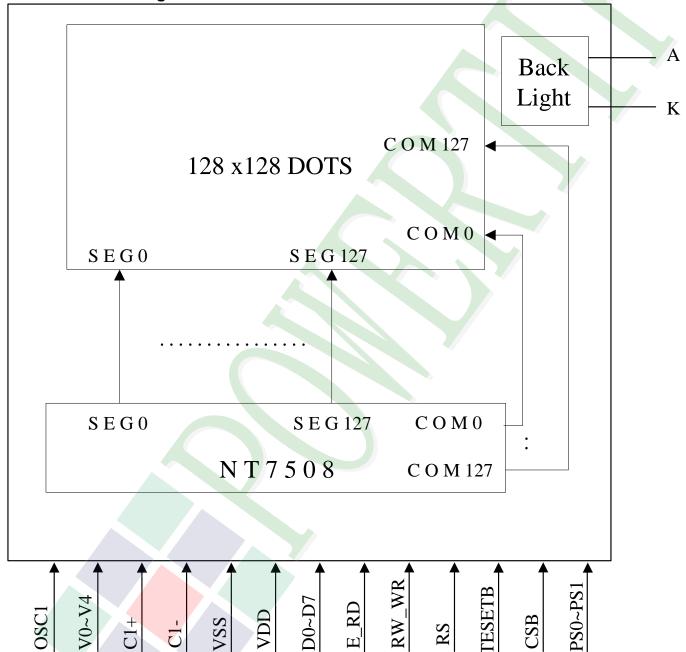
## 2. MODULE STRUCTURE

## 2.1 Counter Drawing

## 2.1.1 LCM Mechanical Diagram

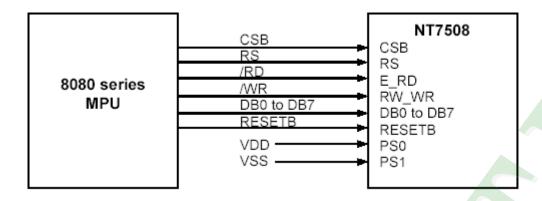
\* See Appendix

## 2.1.2 Block Diagram

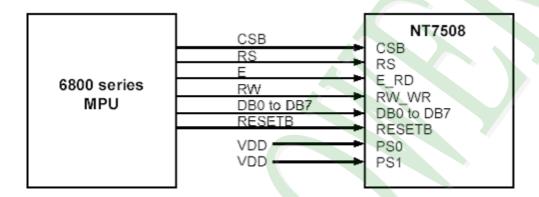




## 2.1.3 Interface for 8080-series(PS0 ="H",PS1= "L")



## 2.1.4 Interface for 6800-series(PS0 ="H",PS1= "H")





# 2.2 Interface Pin Description (Please see , 2.4 Reference Power supply circuit)

Pin	Symbol	Description
01	Α	LED anode supply
02	K	LED cathode supply
03	Α	LED anode supply
04	K	LED cathode supply
05	OSC1	When using internal clock Oscillator, open this pin. When using external clock Oscillator, external OSC input pin.
06	V0	LCD driver supply voltage.  Connecting 1uF/ 25V capacitor between this pin and Vss.
07	V1	LCD driver supply voltage. Connecting 1uF/ 25V capacitor between this pin and Vss.
80	V2	LCD driver supply voltage. Connecting 1uF/ 25V capacitor between this pin and Vss.
09	V3	LCD driver supply voltage. Connecting 1uF/ 25V capacitor between this pin and Vss.
10	V4	LCD driver supply voltage. Connecting 1uF/ 25V capacitor between this pin and Vss.
11	NC	No connecting.
12	NC	No connecting.
13	NC	Not used, Must be open.
14	C1+	C1+ connected to C1- with stabilization capacitor.
15	C1-	(DC/DC voltage converter) 1.0uF~2.2uF/ (max rating) 6V
16	NC	Not used, Must be open.
17	NC	Not used, Must be open.
18	VPC1	This pin is connected to VSS with stabilization capacitor.
10	(VOUT)	1.0uF ~2.2uF / (max rating) 10V
19	VSS	Ground
20	VDD	Power supply
21	DB7	Data Bus
22	DB6	Data Bus
23	DB5	Data Bus
24	DB4	Data Bus
25	DB3	Data Bus
26	DB2	Data Bus

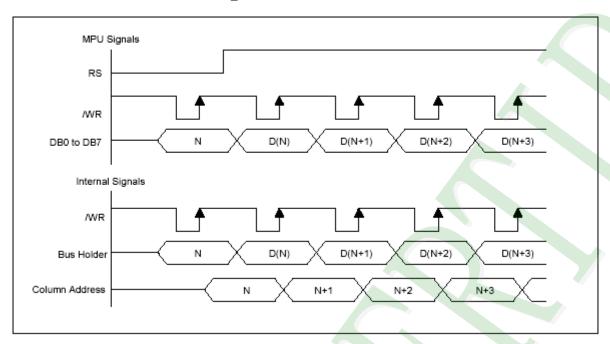


27	DB1	Data Bus						
28	DB0	Data Bus						
		R	Read / Write execution control pin					
			PS1	MPU Type	E RD	Description		
				, , , , , , , , , , , , , , , , , , ,		Read / Write control input pin		
						-RW="H":When E is "H",DB0 to DB7 are		
			Н	6800 series	Е	in an output status.		
29	E_RD					-RW="L": The data on DB0 to DB7 are		
						latched at the falling edge of the E signal		
						Read enable clock input pin		
			L	8080 series	/ RD	When /RD is "L",DB0 to DB7 are in an		
						output status.		
		R	ead	/ Write execu	ution cor	ntrol pin		
			PS1	MPU Type	RW_WR	·		
	RW_WR					Read / Write control input pin		
			Н	6800 series	RW	-RW="H": read		
30						-RW="L" : write		
			_			Write enable clock input pin		
			L	8080 series		The data on DB0 to DB7 are latched at		
							the rising edge of the /WR signal.	
		· D	a aria t	low coloct ion	ut nia			
31	RS		_	ter select inp	•	oto		
31				H": DB[7:0] are display data.  L": DB[7:0] are control data.				
32	DECETR			are reset pir/		ita.		
32	KLOLID			select input p				
33	CSB					ata		
	OOB				B[7:0] are control data.  ata/Instruction I/O is enable.			
		Interface select input pin.						
34	PS1	"H": 6800 series.						
			"L": 8080 series.					
0.7	DCC	Data select input pin.						
35	PS0			Parallel;"L		l.		

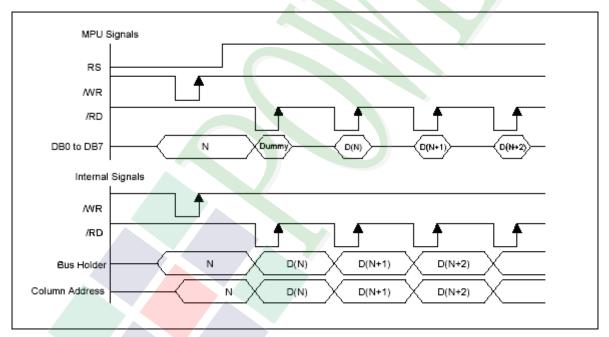


## 2.3 Timing Characteristics

# 2.3.1 Write Timing

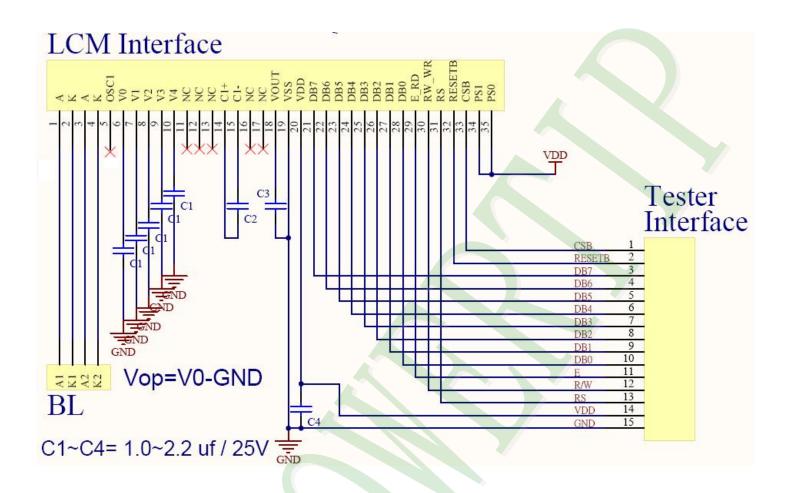


# 2.3.2 Read Timing





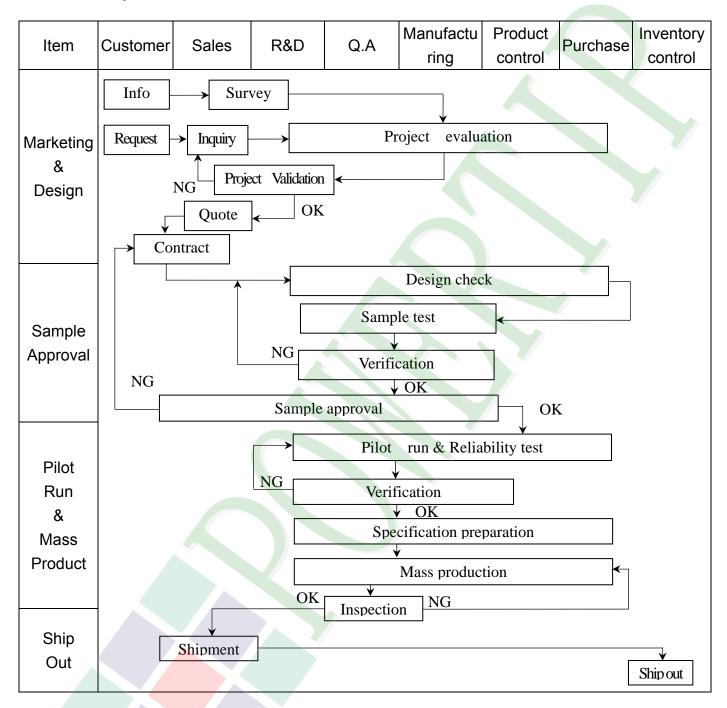
## 2.4 Reference Power supply circuit



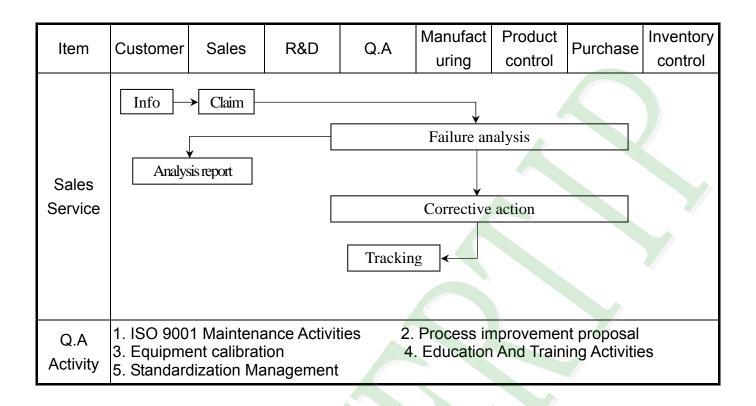


## 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart









## 3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN (Ver. 03).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- ◆OUT Going Defect Level : Sampling.
- **◆**Manner of appearance test :
  - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
  - (2). Standard of inspection: (Unit: mm)
  - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
  - (4). Definition of area. (Fig. 2)

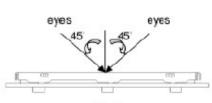


Fig.1

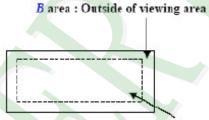


Fig. 2 A area: viewing area

### **♦** Specification:

NO	Item	Criterion	level
		1. 1 The part number is inconsistent with work order of Production.	Major
<b>0</b> 1	Product condition	1. 2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
<b>0</b> 2	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
04	Electrical Testing	4. 2 No function or no display.	Major
		4. 3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major



## ◆Specification For Monotype and Color STN:

<del></del>		Criterion Criterion					
NO	Item	Criterion					
05	Black or white dot · scratch · contamination  Round type	$(\text{diameter}: \Phi) \qquad A \qquad $	acceptance (Q'ty	yithin 3 mm.  y) area  gnore  (Q'ty) B area  Ignore	Minor		
			Acceptance (Q'				
			area	B area			
			t no dense		M		
0 <b>6</b>	Polarizer	$0.20 < \Phi \le 0.50$	3		Minor		
	Bubble	$0.50 < \Phi \le 1.00$	2	Ignore			
		$\Phi > 1.00$	0				
		Total quantity	4				
				<del>_</del>			



◆Specification For Monotype and Color STN:

NO	Item	Criterion					
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  7. 1 General glass chip:					
		7. 1. 1 Chip on panel surface and crack between panels:					
07	The crack of glass	SP SP [NG]	Minor				
		Z L Z					
		$\leq a \qquad \begin{array}{c} \text{Crack can't enter} \\ \text{viewing area} \end{array} \qquad \leq 1/2 \text{ t}$					
	X	$\leq a \qquad \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array}  1/2 \;\; t \;\; < \;\; Z  \leq 2 \;\; t$					



♦Specification For Monotype and Color STN:

NO	Item	Criterion					
NO	Telli	Criterion					
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  7. 1. 2 Corner crack:					
		X X Z					
		X Y Z					
	The crack of glass	$\leq 1/5$ a Crack can't enter viewing area $Z \leq 1/2$ t					
0.7		$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z $\leq$ 2 t					
07		7.2 Protrusion over terminal:	Minor				
		7. 2. 1 Chip on electrode pad:					
		Z X Y Z					
		W X X					
		X Y Z					
		Front $\leq$ a $\leq$ 1/2 W $\leq$ t					
		Back Neglect					



**♦**Specification For Monotype and Color STN:

NO	Item	Criterion	Level
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  Y: The width of crack. W: terminal length a: LCD side length	
07	The crack of glass	7. 2. 2 Non-conductive portion:    X	Minor
		$\begin{array}{c cccc} X & Y & Z \\ & \leq a & \leq 1/3 \ W & \leq t \end{array}$	



◆Specification For Monotype and Color STN: (Ver. 03) NO Item Criterion Level 8. 1 Backlight can't work normally. Major 8. 2 Backlight doesn't light or color is wrong, Major Backlight 80 elements 8. 3 Illumination source flickers when lit. Major 9. 1 Pin type must match type in specification sheet. Major 9. 2 No short circuits in components on PCB or FPC. Major 9. 3 Product packaging must the same as specified on packaging Minor specification sheet. General 09 appearance 9.4 The folding and peeled off in polarizer are not acceptable. Minor 9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) Minor

is  $\leq 1.5$  mm.



# 4. RELIABILITY TEST

4.1 Reliability Test Condition

4.1	Reliability lest Collul						
NO.	TEST ITEM	TEST CONDITION					
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.					
2	Low Temperature Storage Test	Keep in −30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.					
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)					
		Discharge f	with 5 times for each polarity +/-	Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-			
4	ESD Test	<ol> <li>Temperature ambiance: 15°C~35°C</li> <li>Humidity relative: 30%~60%</li> <li>Energy Storage Capacitance(Cs+Cd): 150pF±10%</li> <li>Discharge Resistance(Rd): 330 Ω±10%</li> <li>Discharge, mode of operation:</li> <li>Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)</li> </ol>					
5	Temperature Cycling Storage Test	$-20^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +70^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins})  (5\text{mins})  (5\text{mins})$ $ \leftarrow 10 \text{ Cycle}$ Surrounding temperature, then storage at normal condition 4hrs.}					
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X \ Y \ Z) duration for 2 Hrs</li> </ol>					
			Packing Weight (Kg)	Drop Height (cm)			
			0 ~ 45.4	122			
7	Drop Test		45.4 ~ 90.8	76			
	(Packaged)		90.8 ~ 454	61			
			0ver 454	46			
		Drop direc	tion: $ ilde{*}1$ corner / $3$ edg	es / 6 sides each 1times			



# 5. PRECAUTION RELATING PRODUCT HANDLING

#### 5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

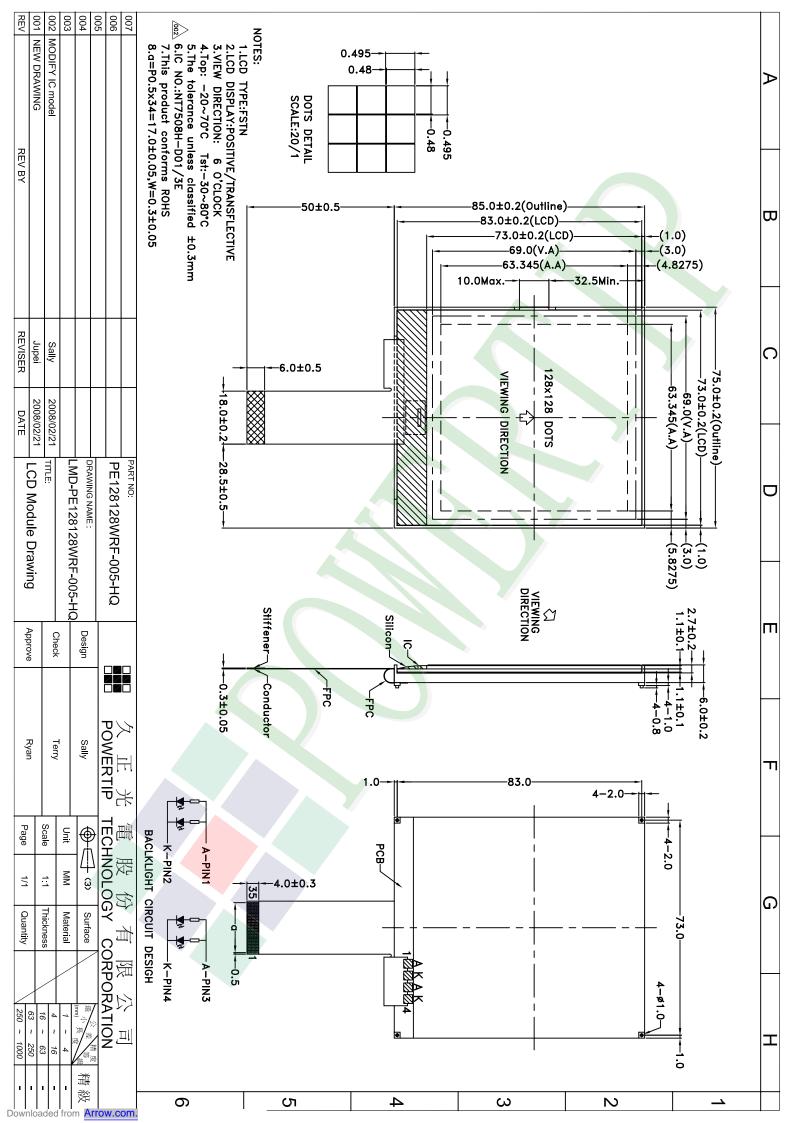
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

#### **5.4 TERMS OF WARRANTY**

- 5.4.1 Applicable warrant period
  - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
  - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver.003			Approve	Check	Contact			
Documents NO. JPKG-PE128128WRF-		裝規格書 ng Specification	ns Ryan	Eddy	Air			
1.包裝材料規格表 (Packaging Material): (per carton)								
No. Item	Model Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight			
1 成品 (LCM)	PE128128WRF-005-HQ	75.0 X 85.0	0.065	198	12.87			
2 靜電袋(1)Antistatic Bag	BAG150120ARABA	150 X 120	0.0018	198	0.3564			
3 氣泡袋(2)Bubble Bag	BAG000000005	150 X 120	0.0016	198	0.3168			
4 A3隔板(3)A2 Partition	BX29500010BZBA	295 X 105 X 3	0.011	78	0.858			
5 B3隔板(4)B2 Partition	BX24500010BZBA	245 X 105 X 3	0.01	24	0.24			
6 氣泡紙(5)Bubble Sheet	BAG280240BWABA	280 X 240	0.006	12	0.072			
7 C3內盒(6)Product Box	BX31025511AABA	310 X 255 X 116	0.263	6	1.578			
8 外紙箱(7)Carton 9	BX52732536CCBA	527 X 325 X 360	1.092	1	1.092			
9_  2.一 整箱總重量 (Total LCD Weigh	t in contant 17.20 Va+1	007						
2.一 经相総里里 (Total LCD Weigh 3.單箱數量規格表 (Packaging Spec		0%			7			
(1)Quantity Of Spacer: A3隔板 X	X 13 , B3隔板 X 4	0.1						
(2)Total LCM quantity in carton : qua	ntity per box 33	x no of boxes	6 =	198				
(5)氣泡紙 —— Bubble Sheet								
(1)靜電袋+(2)氣泡袋+LCM								
Antistatic Bag+Bubble Bag+LCM								
(4) B3隔板——								
B3 Partition		0	10 V					
(2) 1/2 (2) 1/								
(3) A3隔板—— A2 Partition			11					
			$\Downarrow$					
(5) 氣泡紙 ——	₩ J		$\sim$					
Bubble Sheet		(7)外紙箱,		<b>&gt;</b>				
		(7)外紙箱 Carton						
				٠				
(6)C3內盒 Product Box				105 HE				
Troduct Box		POY	VERTIP					
	特記事巧	頁 (REMARK)						
1. Label Specifications:	2. 前、中、後各空一格	<u></u>						
	3. FPC彎折區朝下放置							
MODEL: LOT NO:	7. FFC号加區物下級重							
QUANTITY:								
CHECK:								